



Product Change Notification

Change Notification #: 116269 - 00
Change Title: Intel® NUC Board DE3815TYBE
PCN 116269-00, Product Design,
BIOS Update
Date of Publication: May 21, 2018

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	June 7, 2018
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Description of Change to the Customer:

The Intel® NUC Board SKU listed in the products affected table below will have the following change.

- The BIOS will be updated from TYBYT20H.86A.0009 to TYBYT20H.86A.0018. A complete list of BIOS changes can be found in the BIOS release notes. The BIOS updates and release notes can be found at <http://downloadcenter.intel.com>.

Customer Impact of Change and Recommended Action:

It is recommended that customers evaluate this new BIOS to ensure a smooth transition. This change has been thoroughly evaluated to ensure that there are no quality or reliability implications to our customers. Intel validation of a new board revision does not include testing with older versions of BIOS.

Milestone dates are estimates and subject to change based on business and operational conditions.

Customer can expect to receive mixed inventory until current inventory levels are depleted.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change AA	Post Change AA
BLKDE3815TYBE	933136	H26998-500	H26998-501

PCN Revision History:

Date of Revision:	Revision Number:	Reason:
May 21, 2018	00	Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

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